

INFORMATION DISCLOSURE

Docket No.: 413-010737-US(PAR)

Serial No.: 10/023,564

CITATION FORM FOR
PATENT APPLICATION

Applicant(s): HOISKO et al.

(FORM PTO-1449)

(Substitute)

Filing Date: 12/18/01

Group:

U.S. PATENTS

Initials	Patent Number	Issue Date	Name	Class	Sub-class	Filing date
DN	5,305,423	4/19/94	Clynes	395	2.67	8/19/92
DN	5,941,829	8/24/99	Saltzstein et al.	600	509	10/24/97
DN	5,880,731	3/09/99	Liles et al.	345	349	12/14/95
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U.S. PATENT PUBLICATIONS

Initials	Publication No.	Pub. Date	Name	Class	Sub-class	Filing Date

FOREIGN PATENT DOCUMENTS

Initials	Document Number	Date	Country	Name	Translation? Yes/No/n/a

OTHER DOCUMENTS (Title, Author, Date, Pages, Etc., if known)

	Japanese Patent Document No. JP 2000172589 (English Abstract is attached).

Examiner's Signature:

Date Considered:

08/16/04

Initial if reference was considered, whether or not citation is in conformance with MPEP. Mark through citation if not considered.

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